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<b>INFORMATION DISCLOSURE STATEMENT</b> (Use several sheets if necessary)			Applicant <b>Towle et al.</b>	
			Filing Date <b>9-17-2003</b>	Group Art Unit <b>2811</b>

U.S. PATENT DOCUMENTS							
*EXAMINER INITIALS		DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
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FOREIGN PATENT DOCUMENTS							
*Examiner Initials		Document Number	Publication Date	Country	Class	Subclass	Translation Yes No
			/				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)		
<i>an</i>		Baggs, J; Machon, W; Magill, P; Mis, J; Rinne, G. "Solder Alloy Selection for Flip Chip on Board." International Material and Packaging Society Symposium, Brasleton, Georgia. February 1998. Pages 1-5.
<i>an</i>		Bogaerts, W; Bienstman, P; Baets, R. "Sidewall Roughness in Photonic Crystal Slabs: A Comparison of High-Contrast Membranes and Low-Contrast III-V Epitaxial Structures." 11 <sup>th</sup> International Workshop on Optical Waveguide Theory and Numerical Modelling, April 4-5, 2003, Prague, Czech Republic. Pages 1-4.
<i>an</i>		"Polymer Technology Overview." Optical Crosslinks, Incorporated. 2001. Pages 1-10. Retrieved from internet: <URL: <a href="http://www.opticalcrosslinks.com/pdf/WebPolymerTECHNOLOGYPlatform.pdf">http://www.opticalcrosslinks.com/pdf/WebPolymerTECHNOLOGYPlatform.pdf</a> >.
<i>an</i>		"Polymer Technology: Performance Data and Design Considerations." Optical Crosslinks, Incorporated. 2001. Pages 1-9. Retrieved from internet: <URL: <a href="http://www.opticalcrosslinks.com/pdf/WebPerformanceDataDesignTECHNOLGY.pdf">http://www.opticalcrosslinks.com/pdf/WebPerformanceDataDesignTECHNOLGY.pdf</a> >.
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EXAMINER <i>mg Cy</i>	DATE CONSIDERED <i>03-27-07</i>
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